

SEMI-THERM 28 – Participating Companies

- Advanced Cooling Technologies
- Air Force Research Laboratory
- ANSYS
- Association of Super-Advanced Electronics Technologies
- ATEC
- Budapest University of Technology and Economics
- CALCE
- Celsia Technologies
- Cisco Systems Inc.
- CommScope, Inc.
- DLB Associates
- DS&A LLC
- Electro-Optics Center
- EPFL
- Fujikura
- Georgia Institute of Technology
- Hewlett Packard
- IBM T.J. Watson Research Center
- Indium Corporation
- Infineon Technologies
- Intel Corporation
- Korea Institute of Machinery and Materials
- LSI Corporation
- LTCM
- LTIE
- Mansoura University, Egypt
- Massachusetts of Technology
- Mentor Graphics
- Mentor Graphics, Egypt
- Microsanj
- National Taiwan University
- Naval Surface Warfare Center
- Nuventix
- Ohio University
- ON Semiconductor
- Oracle Corp.
- Penn State University
- Petroleum Institution
- Philips Research
- Purdue University
- Rockwell Collins
- SomelikeitCool
- Southern Methodist University
- Stanford University
- Technical University of Lodz
- Thales Global Services
- University of Arlington, TX
- University of California, Los Angeles
- University of California, Santa Cruz
- University of Maryland
- University of Naples